- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

These devices contain two independent $J-\overline{K}$ positive-edge-triggered flip-flops. A low level at the preset or clear inputs sets or resets the outputs regardless of the levels of the other inputs. When preset and clear are inactive (high), data at the J and \overline{K} inputs meeting the setup time requirements are transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold time interval, data at the J and \overline{K} inputs may be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by grounding \overline{K} and tying J high. They also can perform as D-type flip-flops if J and \overline{K} are tied together.

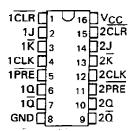
The SN54109 and SN54LS109A are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74109 and SN74LS109A are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each flip-flop)

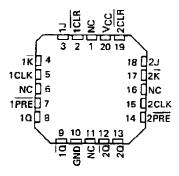
Ĺ		iN	PUTS			OUT	PUTS
	PRE	CLR	CLK	J	K	a	ā
Ţ	L	Н	X	х	Х	H	L
ı	H	L	×	X	X	L	н
۱	L	L	X	Х	Х	нt	Нţ
İ	Н	н	t	L	L	L	Н
l	Н	H	t	Н	L	TOG	GLE
١	Н	Н	Ť	Ł	н	വു	₫₀
1	Н	н	t	Н	н	Н	L
L	Н	н	L	Х	×	<u>0</u> 0	ō₀

 $^{^\}dagger$ The output levels in this configuration are not guaranteed to meet the minimum levels for V_{OH} if the lows at preset and clear are near V_{1L} maximum. Furthermore, this configuration is nonstable; that is, it will not persist when preset or clear return to their inactive (high) level.

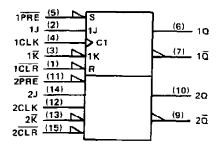
SN54109, SN54LS109A...J OR W PACKAGE SN74109...N PACKAGE SN74LS109A...D OR N PACKAGE (TOP VIEW)



SN54LS109A . . . FK PACKAGE (TOP VIEW)



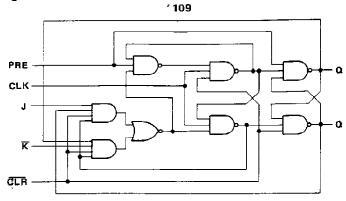
logic symbol‡



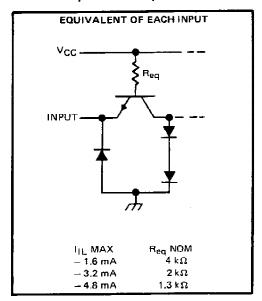
[‡]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

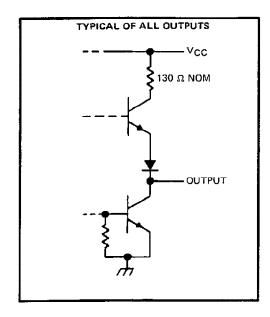
logic diagram (positive logic)

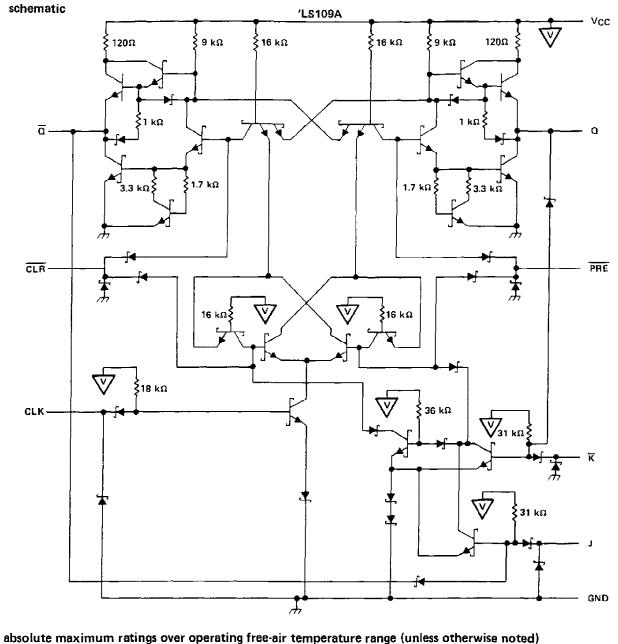


schematics of inputs and outputs



109





Supply voltage, VCC (see Note 1)		7 V
Input voltage: '109		5.5 V
'LS109A		7 V
Operating free-air temperature range:	SN54',	- 55°C to 125°C
	SN74'	0°C to 70°C
Storage temperature range	***************************************	65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



SN54109, SN74109 DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

recommended operating conditions

				SN5410)9		SN7410	9	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				8.0			0.8	V
ІОН	High-level output current				- 0.8			- 0.8	mA
JOL	Low-level output current				16			16	mΑ
	Pulse duration	CLK high or low	20			20			
t _w	- use duration	PRE or CLR law	20			20			ns
tsu	Input setup time before CLK 1		10			10			ns
th	Input hold time-data after CLK1		6			6			ns
ΤA	Operating free-air temperature		55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PAR.	AMETER		TEST CONDITI	onet		SN5410	9		9		
1211	AIVIETEIS !		TEBT CONDITI		MIN	TYP‡	MAX	MIN	TYP‡	MAX	דומט
VIK		V _{CC} = MIN,	= - 12 mA				- 1.5			- 1.5	V
Vон		V _{CC} = MIN, I _{OH} = - 0.8 mA	V _{IH} = 2 V,	V _{IL} ≈ 0.8 V,	2.4	3,4		2.4	3.4		v
VOL		V _{CC} = MIN, I _{OL} = 16 mA	V _{IH} = 2 V,	V _{IL} = 0.8 V,		0.2	0.4		0.2	0.4	٧
11		V _{CC} = MAX,	V _I = 5.5 V				1		·	1	mA
	J or K						40			40	
1	CLR	V _{CC} = MAX,	V. ~ 2.4.V				160			160	_
НІ	PRE or CLK	4GC - MIAA,	V ₁ = 2.4 V				80			80	μА
	Jor \overline{K}						- 1.6			- 1.6	
1	CLR1	V _{CC} = MAX,	V. = 0.4 W				- 4.8			- 4.8	mΑ
'IL	PRE¶	OCC - MAX,	V = 0.4 V				- 3.2			- 3.2	
	CLK		-	<u></u>			- 3.2			-3.2	
los §		V _{CC} = MAX			- 30		- 85	- 30	* ***	- 85	mA
ICC#		V _{CC} = MAX,	See Note 2		T	9	15		9	15	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open. ICC is measured with the Q and Q outputs high in turn. At the time of measurement, the clock input is grounded,

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
fmax				25	33		MHz
tPLH .	PRE	O.			10	15	ns
₹₽HL	.,,	ā			23	35	ns
^t PLH	CLR	ব]	$R_L = 400 \Omega$, $C_L = 15 \rho F$		10	15	ns
tPHL	OLIT	۵			17	25	ns
₹PLH	CLK	QorQ			10	16	ns
tPHL_	- CER	2510			18	28	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 \,^{\circ}\text{C}$.

⁵ Not more than one output should be shorted at a time.

¹ Clear is tested with preset high and preset is tested with clear high.

[#] Average per flip-flop.

SN54LS109A, SN74LS109A DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

recommended operating conditions

		· · · · · · · · · · · · · · · · · · ·	s	N54LS1	09A	SI	N74LS1	09A	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
v _{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.7			0.8	V
Гон	High-level output current		T		- 0.4		••	- 0.4	mA
ТОЦ	Low-level output current				4			8	mA
fclock	Clock frequency		0		25	0		25	MHz
	Pulse duration	CLK high	25		_	25	_		
t₩	Pulse duration	PRE or CLR low	25			25			ns
	Beautiful before Cl K t	High-level data	35			35			
t _{su}	Setup time before CLK 1	Low-level data	25			25			ns
th .	Hold time-data after CLK †		5			5			ns
TA	Operating free-air temperature		- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	RAMETER		TEST CONDITIO	Not.	SI	154LS10	19A	SN	T		
FA	MAINETER	}	IESI COMDITIO	149.	MIN	TYP#	MAX	MIN	TYP‡	MAX	דומט
VIK		VCC - MIN,	I _I = - 18 mA				– 1.5			_ 1.5	V
Vон		V _{CC} = MIN, I _{OH} = - 0.4 mA	V _{IH} = 2 V,	V _{IL} = MAX,	2.5	3.4		2.7	3.4		V
		V _{CC} = MIN, I _{OL} = 4 mA	VIL = MAX,	V _{IH} = 2 V,		0.25	0,4		0.25	0.4	V
VOL		V _{CC} = MIN, I _{OL} = 8 mA	VIL = MAX,	V _{1H} = 2 V,					0.35	0.5	
1.	J, K or CLK	Vcc = MAX,	V ₁ = 7 V				0.1			0.1	mA
11	CLR or PRE	VCC - MAX,	41-14				0.2			0.2	I IIIA
t	J, R or CLK	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	
ΙΗ	CLR or PRE	VCC - WAX,	V - 2.7 V				40		-	40	μА
	J, K or CLK	VCC = MAX,	V. = 0.4 V				- 0.4			- 0.4	
ŊĻ	CLR or PRE	ACC - MWY	V _I = 0.4 V				- 0.8			- 0.8	mA
OS§		VCC = MAX,	See Note 4	<u>.</u>	- 20	-	- 100	- 20		- 100	mA
Icc (Total)	V _{CC} = MAX,	See Note 2			4	8		4	8	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

NOTE 2: With all outputs open, ICC is measured with the Q and Q outputs high in turn. At the time of measurement, the clock input is grounded.

NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V_O = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively with the minimum and maximum limits reduced to one half of their stated values.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	мах	UNIT
f _{max}				25	33		MHz
^t PLH	CLR, PRE	Q or Q	$R_L = 2 k\Omega$, $C_L = 15 pF$		13	25	ns
^t PHL_	or CLK				25	40	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}circ}$ All typical values are at V_{CC} = 5 V, T_A = 25°C. §Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.





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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/30109BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30109BEA	Samples
JM38510/30109BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30109BFA	Samples
JM38510/30109BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30109BFA	Samples
M38510/30109BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30109BEA	Samples
M38510/30109BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30109BEA	Samples
M38510/30109BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30109BFA	Samples
M38510/30109BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30109BFA	Samples
SN54LS109AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS109AJ	Samples
SN54LS109AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS109AJ	Samples
SN74LS109AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS109A	Samples
SN74LS109AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS109A	Samples
SN74LS109ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS109A	Samples
SN74LS109ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS109A	Samples
SN74LS109AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS109AN	Samples
SN74LS109AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS109AN	Samples
SN74LS109ANE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS109AN	Samples
SN74LS109ANE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS109AN	Samples
SN74LS109ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS109A	Samples



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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS109ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS109A	Samples
SNJ54LS109AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS109AJ	Samples
SNJ54LS109AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS109AJ	Samples
SNJ54LS109AW	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS109AW	Samples
SNJ54LS109AW	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS109AW	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN54LS109A, SN74LS109A:

● Catalog: SN74LS109A

● Military: SN54LS109A

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS109ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS109ANSR	so	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS109ADR	SOIC	D	16	2500	340.5	336.1	32.0
SN74LS109ANSR	SO	NS	16	2000	356.0	356.0	35.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
JM38510/30109BFA	W	CFP	16	1	506.98	26.16	6220	NA
M38510/30109BFA	W	CFP	16	1	506.98	26.16	6220	NA
SN74LS109AD	D	SOIC	16	40	507	8	3940	4.32
SN74LS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS109ANE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS109ANE4	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS109AW	W	CFP	16	1	506.98	26.16	6220	NA

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